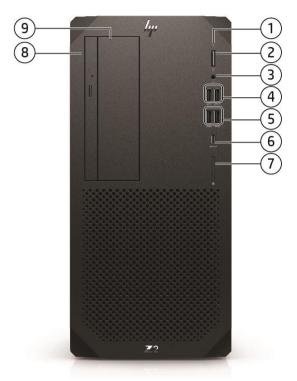
Overview

HP Z2 G9 Tower Workstation Desktop PC



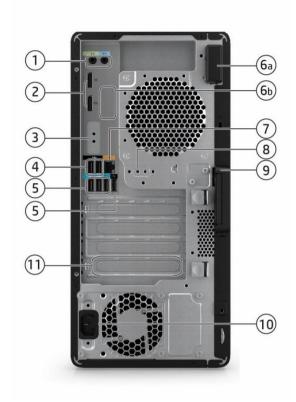
front

- 1. HDD Activity LED
- 2. Power button
- 3. Universal audio jack (with CTIA & OMTP headset support)
- 4. (2) Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge port supports up to 5V/2.1A)
- 5. (2) Type-A SuperSpeed USB 10Gbps signaling rate port

- 6. (1) Type-C[®] SuperSpeed USB 20Gbps signaling rate port (optional, charge supports up to 5V/3A)
- 7. SD card reader 4.0 (optional)
- 8. Slim ODD bay
- 9. External 5.25" bay



Overview



rear

- 1. (1) Audio Line-in jack
 - (1) Audio Line-out jack
- 2. (2) DisplayPort 1.4
- 3. Flex I/O module: choose one from the following:
 (1) DisplayPort 1.4, (1) HDMI 2.0b, (1) VGA, (1) Dual Type-A
 SuperSpeed USB 5Gbps signaling rate port, (1) Type-C®
 SuperSpeed USB 10Gbps signaling rate port (Power Delivery
 15W, Alt Mode DisplayPort), (1) 2nd 1 GbE LAN, (1) Thunderbolt
 3 with Type-C® SuperSpeed/ USB4 40Gbps signaling rate*
 (cabled to PCIe AIC) (1) 1Gbps Fiber LC NIC
- 4. (2) Hi-Speed USB 480Mbps signaling rate port
- 5. (2) Type-A SuperSpeed USB 10Gbps signaling rate port
 - (1) Type A SuperSpeed USB 5Gbps signaling rate port
 - (1) Hi-Speed USB 480Mbps signaling rate port
- *Maximum speed requires DisplayPort™ and PCIe aggregation.
- **Thunderbolt only support on PCI-E slot4.

Note: Onboard Display support DP1.4/HBR2. Flex I/O module Display support DP1.4/HBR3. Resolution all support up to 5120x3200 24bpp @60Hz.

Form Factor

Tower

Operating Systems

Preinstalled:

- Windows 11 Pro HP recommends Windows 11 Pro²
- Windows 11 Home HP recommends Windows 11 Pro²
- Windows 10 Pro (available through downgrade rights from Windows 11 Pro) 1,2,3

- 6. WLAN Antenna (optional)
 - a. Internal
 - b. External
- 7. RJ-45
- 8. 2nd serial port (optional)
- 9. Hood lock (optional)
- 10. Power connector

Overview

- Linux®-ready⁵
- Ubuntu 20.04 LTS⁴

Web-supported only:

Windows 10 Enterprise 64²

Supported Version:

- HP tested Windows 10, versions 20H2, 21H1 and 21H2 on this platform. For testing information on newer versions of Windows 10, please see: https://support.hp.com/document/c05195282.
- Red Hat® Enterprise Linux® Workstation 86
- SUSE Linux® Enterprise Desktop 156
- Ubuntu 20.04, 22.04 LTS⁵

¹ Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

⁴ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

⁵A certified preloaded version of Ubuntu® 20.04 LTS is available from HP for this platform. Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for upgrades.

⁶For detailed Linux[®] OS/hardware support information, see:

http://www.hp.com/support/linux_hardware_matrix

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

Processors

| Name | Cores | Clock Speed (GHz) | Thread s | Cache (MB) | Memory Speed (MT/s) ⁵ | Hyper- Threading | Integrated Graphics | Intel® Turbo Boost Technology³ | Intel® vPro® | 16GB Intel® Optane™ memory² | TDP (W) |
|--------------------------------------|-------|-------------------------|-------------|---------------|--|---------------------|----------------------------|--------------------------------------|--------------|--------------------------------------|------------|
| Intel® Core™ i9- 12900K Processor | 16 | 3.2 | 24 | 30 | 4800 | Y | Intel® UHD Graphics 770 | 5.2 | Υ | N | 125 |
| Intel® Core™ i9- 12900 Processor | 16 | 2.1 | 24 | 30 | 4800 | Y | Intel® UHD Graphics 770 | 5.1 | Y | N | 65 |



Overview

| Intel® Core™ i7- 12700K Processor | 12 | 3.6 | 20 | 25 | 4800 | Υ | Intel® UHD Graphics 770 | 5.0 | Υ | N | 125 |
|--------------------------------------|----|-----|----|----|------|---|----------------------------|-----|-----|---|-----|
| Intel® Core™ i7- 12700 Processor | 12 | 2.1 | 20 | 25 | 4800 | Υ | Intel® UHD Graphics 770 | 4.9 | Υ | N | 65 |
| Intel® Core™ i5- 12600K Processor | 10 | 3.7 | 16 | 20 | 4800 | Υ | Intel® UHD Graphics 770 | 4.9 | Υ | N | 125 |
| Intel® Core™ i5- 12600 processor | 6 | 3.3 | 12 | 18 | 4800 | Υ | Intel® UHD Graphics 770 | 4.8 | Υ | N | 65 |
| Intel® Core™ i5- 12500 processor | 6 | 3.0 | 12 | 18 | 4800 | Υ | Intel® UHD Graphics 770 | 4.6 | Y | N | 65 |
| Intel® Core™ i5- 12400 processor | 6 | 2.5 | 12 | 18 | 4800 | Υ | Intel® UHD Graphics 730 | 4.4 | N/A | N | 65 |
| Intel® Core™ i3- 12300 processor | 4 | 3.5 | 8 | 12 | 4800 | Υ | Intel® UHD Graphics 730 | 4.4 | N/A | N | 60 |
| Intel® Core™ i3- 12100 processor | 4 | 3.3 | 8 | 12 | 4800 | Y | Intel® UHD Graphics 730 | 4.3 | N/A | N | 60 |

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

⁴ Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

Memory will run at 4400 speed (MT/s) if there is one DIMM per channel. 2 DIMMS per channel will run 4800 speed (MT/s)

Note: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

ColorBlackConvertibilityNoExpansion Slots (see
system board section for
more details)Slot 1:
PCIe Gen5 x16
Slot 2:

PCle Gen3 x1 - with x4 Connector

Slot 3:

PCIe Gen3 x4 - with x16 Connector

Slot 4: PCIe Gen3 x4

Expansion Bays (see (2) Internal 3.5" bays storage section for more (1) External 5.25" bay

(1) Internal 2.5" bay (for SSD only)

(1) Dedicated 9.5mm slim optical disk drive bay



details)

² Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

³ Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

Overview

Front I/O 2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge port supports up to 5V/2.1A), 2 Type-A

SuperSpeed USB 10Gbps signaling rate port, 1 Type-C SuperSpeed® USB 20Gbps signaling rate port

(charge supports up to 5V/3A, optional), 1 SD card reader (optional), 1 universal audio jack

(1) Hi-Speed USB 480Mbps signaling rate header for SD card reader Internal I/O [5]

(1) serial port available with header

(1) serial and PS/2 available with header

2 DisplayPort 1.4 [3], 1 Audio Line out, 1 Audio Line in, 1 RJ-45, 3 Hi-Speed USB 480Mbps signaling rate Rear I/O

> port, 2 Type-A SuperSpeed USB 10Gbps signaling rate port, 1 Type-A SuperSpeed USB 5Gbps signaling rate port, 1 serial (optional), 1 Flex I/O port (VGA, HDMI 2.0b, DisplayPort 1.4, Type-C® SuperSpeed USB 10Gbps signaling rate port (Power Delivery 15W, Alt Mode Display Port), Dual Tye-A SuperSpeed USB 5Gbps signaling rate port, 2nd 1GbE LAN, 1 Thunderbolt 3 with SuperSpeed/USB4 Type-C® 40Gbps

signaling rate (cabled to PCIe AIC). 1 1Gbps Fiber LC NIC

Flex IO* – choose one of the following options: 1 DisplayPort™ 1.4, 1 HDMI 2.0b, 1 VGA,1 2nd 1GbE LAN, Optional I/O

1 1Gbps Fiber LC NIC, 1 Dual SuperSpeed USB Type-A 5Gbps signaling rate, 1 SuperSpeed USB Type-C® 10Gbps signaling rate (15W USB Power Delivery, Alt Mode DisplayPort™) 1 Thunderbolt™ 3 with SuperSpeed USB4 Type-C® 40Gbps signaling rate (cabled to PCIe® AIC): Front - 1 SuperSpeed USB Type-C[®] 20Gbps signaling rate (1 charging), 1 SD card reader; Rear –1 serial; Front – choose one of the following options: 1 SuperSpeed USB Type-C® 20Gbps signaling rate (1 charging), 1 SD 4.0 card reader

*Flex IO port and one PCIe slot will be occupied when Thunderbolt is installed. Thunderbolt will be

available in Q2, 2022 (1st refresh).

Interfaces Supported SD card reader (optional)

On-board RAID Support SATA and NVME RAID 0 Striped Array

SATA RAID and NVME RAID 1 Mirror Array

Chassis Dimensions (H x H: 14" [356mm]

W x D) W: 6.7" [169mm]

D: 15.2" [385mm]

Packaged Dimensions H: 20.39" (518mm)

W: 11.61" (295mm)

D: 19.29" (490mm)

Rack Dimensions

Weight Exact weights depend upon configuration (System weight only).

Starting at 6.2kg (13.7lbs.)

Operating: 5° to 35° C (40° to 95° F) **Temperature**

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for

every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb **Humidity**

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non- Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

pressurized)6 Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Temperature for details.

700W wide-ranging, active Power Factor Correction, 92% Efficiency, 500W wide-ranging, active Power **Power Supply**

Factor Correction, 90% Efficiency. 450W wide-ranging, active Power Factor Correction, 90% Efficiency.

350W wide-ranging, active Power Factor Correction, 92% Efficiency.

NOTE: The Power Supply Efficiency, Report for the 700W 92% Efficiency, 500W 90% Efficiency, 450W

90% Efficiency and 350W 92% Efficiency Power Supply may be found at the following links:

700W PSU:



Overview

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

500W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

450W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

350W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

Backup Devices For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup

System offerings, please visit http://www.hp.com/go/connect

Chipset Intel® W680 chipset

Memory 4 DIMM slots, supporting up to 128GB ECC/non-ECC, DDR5 4800 MT/s speed depending on the system

configuration



Supported Components

| Processors | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|------------|--|-----------------------|------------|---------------------------|------------------|
| | 12th Generation Intel® Core™ Processors* | | | | |
| | Intel® Core™ i9-12900K Processor | Υ | N | | |
| | Intel® Core™ i9-12900 Processor | Υ | N | | |
| | Intel® Core™ i7-12700K Processor | Υ | N | | |
| | Intel® Core™ i7-12700 Processor | Υ | N | | |
| | Intel® Core™ i5-12600K Processor | Υ | N | | |
| | Intel® Core™ i5-12600 processor | Υ | N | | |
| | Intel® Core™ i5-12500 processor | Υ | N | | |
| | Intel® Core™ i5-12400 processor | Υ | N | | 1 |
| | Intel® Core™ i3-12300 processor | Υ | N | | 1 |

Note: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

Υ

N

NOTE 1: These processors support only non-ECC memory

Intel[®] Core™ i3-12100 processor

NOTE 2: No iGfx. A discrete graphics card must be purchased at the same time.

| SATA Hard Drives | | Factory Configured | Option Kit | Option Kit Part Number |
|-------------------------|---|-----------------------|--------------|---------------------------|
| | 500GB SATA 7200 rpm 6Gb/s 3.5" HDD | Υ | Υ | LQ036AA |
| | 1TB SATA 7200 rpm 6Gb/s 3.5" HDD | Υ | Υ | LQ037AA |
| | 2TB SATA 7200 rpm 6Gb/s 3.5" HDD | Υ | Υ | QB576AA |
| | 1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Υ | Υ | WOR10AA |
| | 2TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Υ | Υ | 2Z274AA |
| | 4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Υ | Υ | K4T76AA |
| | 8TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Υ | Υ | 2Z273AA |
| | 12TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) | Υ | Υ | 5S461AA |
| | 500GB SATA 7.2K SED HDD | Υ | Υ | D8N29AA |
| | NOTE: HDD option kits also require purchase of separate ca | able kit (availab | le Sept '22) | & NQ099AA |
| PCIe Solid State Drives | | | | |
| | HP ZTurbo 256GB TLC Z2 G9 TWR/SFF SSDKit | Υ | Υ | 141L5AA/AT |

| HP ZTurbo 256GB TLC Z2 G9 TWR/SFF SSDKit | Υ | Υ | 141L5AA/AT |
|---|---|---|------------|
| HP ZTurbo 512GB PCIe-Gen 4x4 TLC Z2 SSDKit | Υ | Υ | 201G0AA/AT |
| HP ZTurbo 512GB PCle-Gen 4x4 SED Z2 SSDKit | Υ | Υ | 201F9AA |
| HP ZTurbo 1TB PCle-Gen 4x4 TLC Z2 SSDKit | Υ | Υ | 201F5AA/AT |
| HP ZTurbo 2TB PCle-Gen 4x4 TLC Z2 SSDKit | Υ | Υ | 201F8AA |
| HP ZTurbo 256GB SED Opal 2 TLC Z2 G9 TWR/SFF SSDKit | Υ | Υ | 141M3AA/AT |
| Z Turbo 1TB 2280 PCIe-Gen4x4 Self Encrypted OPAL2 TLC M.2 Z2 SSD | Υ | Y | 223A3AA/AT |
| Z Turbo 2TB 2280 PCIe-Gen4x4 Self Encrypted OPAL2 TLC M.2 Z2 SSD | Υ | Y | 223A4AA/AT |



1

Supported Components

| 256GB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD | Υ | Υ | 4M9Z1AA |
|---|---|---|---------|
| 512GB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD | Υ | Υ | 4M9Z2AA |
| 1TB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD | Υ | Υ | 4M9Z3AA |
| Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 Z2 Kit SSD | Υ | Υ | 5S492AA |
| Z Turbo 2TB PCIe-4x4 TLC SSD Module | Υ | Υ | 38T75AA |
| Z Turbo 1TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module | Υ | Υ | 38T76AA |
| Z Turbo 1TB PCIe-4x4 TLC SSD Module | Υ | Υ | 38T77AA |
| Z Turbo 2TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module | Υ | Υ | 38T79AA |
| Z Turbo 512GB PCIe-4x4 TLC SSD Module | Υ | Υ | 38T80AA |
| Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module | Υ | Υ | 38T81AA |
| Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 SSD Module | Υ | Υ | 5S496AA |
| Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module | Υ | Υ | 5S497AA |
| Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z2 Kit SSD | Υ | Υ | 5S498AA |

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

| Graphics | | Factory Configured | Option Kit | Option Kit Part Number | Supported # of cards |
|--------------------------------|--|-----------------------|------------|---------------------------|----------------------|
| Graphics Cable Adapters | HP DisplayPort To HDMI True 4k Adapter | Υ | Υ | 2JA63AA | |
| | HP Single miniDP-to-DP Adapter Cable | Υ | Υ | 2MY05AA | |
| | HP DisplayPort To DVI-D Adapter | Υ | Υ | FH973AA | |
| | HP DisplayPort To DVI Adapter (Bulk 90) | Υ | Υ | FH973A6 | |
| | HP DisplayPort To VGA Adapter | Υ | Υ | AS615AA/AT | |
| | HP DisplayPort to VGA Adapter Bulk Qty.90) | Υ | Υ | AS615A6 | |
| | HP DisplayPort To VGA Adapter | Υ | Υ | F7W97AA | |
| | HP USB-C to DisplayPort Adapter | Υ | Υ | 4SH08AA | |
| | HP USB-C to HDMI Adapter | Υ | Υ | 4SH07AA | |
| | HP USB-C to VGA Adapter | Υ | Υ | 4SH06AA | |
| Entry 3D | NVIDIA® T400 2 GB Graphics ^{1,2} | Υ | Υ | 340K8AA | 2 |
| | NVIDIA® T400 4 GB Graphics ² | Υ | Υ | 5Z7EOAA/AT | 2 |
| | NVIDIA® T600 4 GB Graphics ^{1,2} | Υ | Υ | 340K9AA | 2 |
| Mid-range 3D | NVIDIA® T1000 4 GB Graphics ² | Υ | Υ | | 2 |
| | NVIDIA® T1000 8 GB Graphics ² | Υ | Υ | 5Z7D8AA/AT | 2 |
| | NVIDIA RTX™ A2000 12GB Graphics*2 | Υ | Υ | 5Z7D9AA/AT | 2 |
| | AMD Radeon™ Pro W6600 Graphics (8GB GDDR6 dedicated) * | Υ | Υ | 340K5AA | 1 |
| High-End 3D | AMD Radeon™ Pro W6800 Graphics (32 GB GDDR6 dedicated) * | Υ | Υ | 340K7AA | 1 |
| | NVIDIA® GeForce RTX 3060 12 GB GDDR6 FH PCIe x16 Graphics | Υ | Υ | | 1 |
| | NVIDIA® GeForce RTX 3070 8 GB GDDR6 FH PCIe x16 Graphics | Υ | Υ | | 1 |
| | NVIDIA® GeForce RTX 3080 10 GB GDDR6X FH PCIe x16 Graphics | Υ | Υ | | 1 |
| | NVIDIA® RTX™ A5000 24 GB Graphics* | Υ | Υ | 20X23AA/AT | 1 |



Supported Components

Note 1: May go End of Life in late 2022.

Note 2: When dual graphics is supported (expected May 2022), the 450W and 500W base units will require the AMO HP Z2 TWR Dual Front Fan Kit part number 4N007AA.

^{**} Requires at least 500W chassis.

| Memory | | Factory Configured | Option Kit | Option Kit Part Number | Support Notes |
|--------|---------------------------------------|-----------------------|------------|---------------------------|------------------|
| | HP 8GB (1x8GB) DDR5-4800 nECC UDIMM | Υ | Υ | 4M9X9AA | |
| | HP 16GB (1x16GB) DDR5-4800 nECC UDIMM | Υ | Υ | 4M9Y0AA | |
| | HP 16GB (1x16GB) DDR5-4800 ECC UDIMM | Υ | Υ | 4M9Y1AA | 1 |
| | HP 32GB (1x32GB) DDR5-4800 nECC UDIMM | Υ | Υ | 4M9Y2AA | |
| | HP 32GB (1x32GB) DDR5-4800 ECC UDIMM | Υ | Υ | 4M9Y3AA | 1 |

NOTE 1: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700K, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

NOTE 2: Two channels of DDR5 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

NOTE 3: Though the memory modules can run up to 4800MHz, the current platform will support maximum memory speed of 4400MHz.

The system speed will be determined by a number of key factors:

| Module Configuration | Description of configuration | Max Memory Speed (Actual Memory speed is dependent on CPU) |
|--------------------------------------|---|--|
| Single DIMM per channel | Configurations that contain only one or two DIMM modules with DIMMs only in the black slots | 4400MHz |
| Two single ranked DIMMs in a channel | Configurations with 3 or 4 single ranked DIMMs (8GB and 16GB) installed in a system | 4000MHz |
| Two dual ranked DIMMs in a channel | Configurations with 3 or 4 dual ranked DIMMs (32GB) installed in a system | 3600MHz |

Note: When more than one memory slot is populated, symmetric configurations are required for 2 DIMMs per channel. Mix of different part numbers or mix of single and dual ranks within a channel is not allowed.

| Optical and Removable Storage | | Factory Configured | Option Kit | Option Kit Part Number |
|----------------------------------|--|-----------------------|------------|---------------------------|
| | HP DX175 Removable HDD Frame/Carrier | Υ | Υ | 1ZX71AA |
| | HP DX175 Removable HDD Spare Carrier | Υ | Υ | 1ZX72AA |
| | HP Z2 TWR SuperMulti DVD-Writer 9.5mm Slim ODD | Υ | Υ | 4L5K0AA |
| | HP Z2 TWR DVD-ROM 9.5mm Slim ODD | Υ | Υ | 4L5K1AA |
| | HP CRU QX328 5.25 in Front Removable Frame/Carrier | Υ | Υ | 4N011AA |
| | HP CRU SHIPS M.2 2TB Storage Module | Υ | Υ | 56Q87AA |
| | HP CRU SHIPS M.2 1TB Storage Module | Υ | Υ | 56Q88AA |
| | HP CRU SHIPS M.2 512GB Storage Module | Υ | Υ | 56Q89AA |



^{*} Requires 700W chassis.

Supported Components

HP CRU SHIPS M.2 Spare Carrier

γ

γ

Ν

Υ

633X9AA

NOTE: With Blu-Ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this Desktop PC.

NOTE: Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives. Note that DVD-RAM cannot read or write to 2.6GB Single Sided/5.2 Double Sided-Version 1.0 Media.

| Networking and Communications | | Factory Configured | Option Kit | Option Kit Part Number |
|----------------------------------|--|-----------------------|------------|---------------------------|
| | Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro® with Intel® AMT 16.0) | Υ | N | |
| | HP 1GbE LAN Flex Port 2020 | Υ | Υ | 141J6AA/AT |
| | HP Flex 1GbE Fiber LC Single Port | Υ | Υ | 20J15AA |
| | NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE SFP28 | | | |
| | NIC ¹ | Υ | Υ | 436M8AA |
| | Intel Ethernet I350-T4 4-Port 1Gb NIC* | N | Υ | W8X25AA |
| | Intel X550 10GBASE-T Dual Port NIC | Υ | Υ | 1QL46AA |
| | Intel Ethernet Network Adapter I225-T1 | Υ | Υ | 406L9AA |

^{*}Intel I350-T4 4-port GbE NIC is an After Market Option only.

Intel Wi-Fi 6E AX211 BT 5.2 M.2 non-vPro1,**

NOTE: The integrated network connection is required to support Intel® vPro® Technology.

NOTE: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

NOTE: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



¹ Intel AX211 with Internal antenna support WIFI 6/WIFI 6E

^{**}Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Supported Components

| HP USB 320K Keyboard | Input Devices | | Factory Configured | Option Kit | Option Kit Part Number |
|--|-----------------------|--|-----------------------|------------|---------------------------|
| HP 320M Wired Mouse | | HP USB 320K Keyboard | _ | - | |
| HP 125 Wired Keyboard | | | Υ | Υ | 9VA80AA |
| HP 125 Wired Keyboard | | HP Wired Desktop 320MK Mouse and Keyboard | N | Υ | 9SR36AA |
| HP 655 Wireless USB BLK KBD/MSE Kit N | | | Υ | Υ | 266C9AA |
| HP 125 Wired Mouse | | HP 975 USB+BT Dual Mode Wireless | N | Υ | 3Z726AA |
| HP 128 Laser Wired Mouse | | HP 655 Wireless USB BLK KBD/MSE Kit | N | Υ | N/A |
| HP 935 Creator Wireless Mouse HP 455 Programmable Wireless Keyboard HP 455 Programmable Wireless Keyboard (Bulk Qty.12) Y 4R177A6 HP 455 Programmable Wireless Keyboard (Bulk Qty.12) Y 4R009A6 HP 655 Wireless Keyboard and Mouse Combo Y 4R009A6 HP 655 Wireless Keyboard and Mouse Combo Y 4R009A6 HyperX Cloud MIX Wireless GAM HEADSET N Y 4P5K9AA HyperX Cloud MIX Wireless GAM HEADSET N Y 4P4F2AA HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (HX-HSCF-BK/AM) HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P5L4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) HP 106E LAN Flex Port 2020 Y Y 141J6AA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J7AA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J8AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141J8AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K6AA/AT HP Flex 1GbE Fiber LC Single Port Other Hardware HP Single TBT3 wType C and USB4 PCle x4 Card Y N N/A HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 Power Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter | | HP 125 Wired Mouse | Υ | Υ | 265A9AA |
| HP 455 Programmable Wireless Keyboard (Bulk Qty.12) | | HP 128 Laser Wired Mouse | Υ | Υ | 265D9AA |
| HP 455 Programmable Wireless Keyboard (Bulk Qty.12) | | HP 935 Creator Wireless Mouse | N | Υ | 1D0K8AA |
| HP 655 Wireless Keyboard and Mouse Combo Y Y 4R009AA HP 655 Wireless Keyboard and Mouse Combo (Blk Qty.10) Y 4R009A6 HP 655 Wireless Keyboard and Mouse Combo (Blk Qty.10) Y 4R009A6 HP 655 Wireless Keyboard and Mouse Combo (Blk Qty.10) Y 4R009A6 HP 655 Wireless GAM HEADSET N Y 4P5K9AA HyperX Cloud Kight - Wireless Gaming Headset (Black-Red) N Y 4P4F2AA HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) N Y 4P5L4AA (HX-HSCF-BK/AM) HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) N Y 4P5P8AA Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear I0) Plex Port 2020 Y Y 141J5AA/AT HP DP Flex Port 2020 Y Y 141J5AA/AT HP DP ILEX Port 2020 Y Y 141J5AA/AT HP DBH ILEX PORT 2020 Y Y 141J5AA/AT HP DBH ILEX PORT 2020 Y Y 141K5AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K5AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K5AA/AT HP VGA Flex Port 2020 Y Y 141K5AA/AT HP VGA Flex Port 2020 Y Y 141K5AA/AT HP Flex 1GbE Fiber LC Single Port Y Y 20J15AA Other Hardware HP Single TBT3 wType C and USB4 PCle x4 Card Y N N/A N/A HP Z2 Internal Serial Port and PS/2 Port Y Y 141K5AA/AT HP Z2 Power Cord Kit Y Y 11N1D5AA HP Z2 Power Cord Kit Y Y 11N1D5AA HP Z2 Power Cord Kit Y Y 11N1D5AA HP Z2 Z0 d serial port adapter Y Y 141K5AA/AT 141L2AA/AT 141L2A | | HP 455 Programmable Wireless Keyboard | Υ | Υ | 4R177AA |
| HP 655 Wireless Keyboard and Mouse Combo (Blk Qty.10) HyperX Cloud MIX Wireless GAM HEADSET N Y 4P5K9AA HyperX Cloud Core BLK GAM HEADSET N Y 4P4F2AA HyperX Cloud Core BLK GAM HEADSET N Y 4P4F2AA HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) HP 1GbE LAN Flex Port 2020 HP 1GbE LAN Flex Port 2020 Y Y 141J5AAA/AT HP DDH Flex Port 2020 Y Y 141J8AA/AT HP DUBI USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J8AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K6AA/AT HP UGA Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Other Hardware HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP 32 Power Cord Kit HP 32 Tower Dust Filter Y 141K8AA/AT HP 22 Internal Serial Port adapter HP 32 Tower Dust Filter | | HP 455 Programmable Wireless Keyboard (Bulk Qty.12) | Υ | Υ | 4R177A6 |
| HyperX Cloud MIX Wireless GAM HEADSET N Y 4P5K9AA HyperX Cloud Core BLK GAM HEADSET N Y 4P4F2AA HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) N Y 4P5L4AA HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) N Y 4P5L4AA HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) N Y 4P5P8AA Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) Flex Port 2020 Y Y 141J6AA/AT HP DF Flex Port 2020 Y Y 141J7AA/AT HP DDF Flex Port 2020 Y Y 141J7AA/AT HP DUBL USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J8AA/AT HP HDMI Flex Port 4020 Y Y 141K6AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y Y 141K6AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y Y 141K6AA/AT HP Flex 1GbE Fiber LC Single Port Y Y 20J15AA HP Flex 1GbE Fiber LC Single Port Y Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Y Y Y 141K7AA/AT HP T22 Internal Serial Port and PS/2 Port Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 141K8AA/AT HP Z2 Power Cord Kit Y Y 141K8AA/AT HP Z2 Power Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141K8AA/AT | | HP 655 Wireless Keyboard and Mouse Combo | Υ | Υ | 4R009AA |
| HyperX Cloud Core BLK GAM HEADSET N Y 4P4F2AA HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (RMX-HSCF-BK/AM) N Y 4P5L4AA (HX-HSCF-BK/AM) N Y 4P5L4AA HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) N Y 4P5P8AA Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) Factory Configured Option Kit Number HP 1GbE LAN Flex Port 2020 Y Y Y 141J6AA/AT HP DDF Flex Port 2020 Y Y Y 141J7AA/AT HP DUal USB-A 3.2 Gen1 Flex Port 2020 Y Y Y 141J8AA/AT HP HDMI Flex Port HP Flex Port 2020 Y Y Y 141K6AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y Y 141K6AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y Y 141K6AA/AT HP Flex 1GbE Fiber LC Single Port Y Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Y Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Y Y Y 141K9AA/AT HP Z2 Internal Serial Port and PS/2 Port Y Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y Y 141K8AA/AT HP Z2 Power Cord Kit Y Y Y 141K8AA/AT HP Z2 Internal Serial port adapter Y Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141K8AA/AT | | HP 655 Wireless Keyboard and Mouse Combo (Blk Qty.10) | Υ | Υ | 4R009A6 |
| HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (HX-HSCF-BK/AM) HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMISTX-XX-BK/G) N Y 4P5F8AA Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) HP 1 GbE LAN Flex Port 2020 Y Y Y 141J6AA/AT HP DP Flex Port 2020 Y Y Y 141J7AA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y Y 141J8AA/AT HP HDMI Flex Port HP 1 USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y Y 141J8AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y Y 141K6AA/AT HP Flex 1 GbE Fiber LC Single Port Other Hardware HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 1 Tower Dust Filter | | HyperX Cloud MIX Wireless GAM HEADSET | N | Υ | 4P5K9AA |
| (HX-HSCF-BK/AM) N Y 4P544AA HyperX Cloud Stinger Core GAM HEADSET PC N Y 4P4F4AA HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) N Y 4P5P8AA Note: Keyboard and Mouse are optional or add on features. Factory Option Kit Part Number HP 1GbE LAN Flex Port 2020 Y Y 141J6AA/AT HP DP Flex Port 2020 Y Y 141J7AA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J8AA/AT HP HDMI Flex Port Y Y 141K6AA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Y Y 20J15AA Other Hardware Factory Configured Option Kit Part Number N/A N/A HP Single TBT3 wType C and USB4 PCle x4 Card Y N N/A HP Z2 Internal Serial Port and PS/2 Port Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 141K9AA/AT < | | HyperX Cloud Core BLK GAM HEADSET | N | Υ | 4P4F2AA |
| HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) N Y 4P5P8AA Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) | | | N | Υ | 4P5L4AA |
| Note: Keyboard and Mouse are optional or add on features. Flex Module (Rear IO) Pactory Configured Option Kit Part Number HP 1GbE LAN Flex Port 2020 Y Y 141J6AA/AT HP DP Flex Port 2020 Y Y 141J7AA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J8AA/AT HP HDMI Flex Port HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K6AA/AT HP Flex 1GbE Fiber LC Single Port Other Hardware Factory Configured Option Kit Number HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter | | HyperX Cloud Stinger Core GAM HEADSET PC | N | Υ | 4P4F4AA |
| Flex Module (Rear IO) HP 1GbE LAN Flex Port 2020 YYY141JFAA/AT HP DP Flex Port 2020 YYY141JFAA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 YYY141JBAA/AT HP HDMI Flex Port HP USB-C 3.2 Gen2 Alt Flex Port 2020 YYY141JBAA/AT HP USB-C 3.2 Gen2 Alt Flex Port 2020 YYY141K6AA/AT HP VGA Flex Port 2020 YYY141K6AA/AT HP Flex 1GbE Fiber LC Single Port YY20J15AA Other Hardware Factory Configured Option Kit Part Number HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter P X9 Potion Kit Part Number 141K9AA/AT HP Z2 Tower Dust Filter | | HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G) | N | Υ | 4P5P8AA |
| ConfiguredOption KitNumberHP 1GbE LAN Flex Port 2020YY141J6AA/ATHP DP Flex Port 2020YY141J7AA/ATHP Dual USB-A 3.2 Gen1 Flex Port 2020YY141J8AA/ATHP HDMI Flex PortYY69D47AA/ATHP USB-C 3.2 Gen2 Alt Flex Port 2020YY141K6AA/ATHP VGA Flex Port 2020YY141K7AA/ATHP Flex 1GbE Fiber LC Single PortYY20J15AAOther HardwareFactory Configured Option Kit Part NumberHP Single TBT3 wType C and USB4 PCle x4 CardYNN/AHP Z2 Internal Serial Port and PS/2 PortYY141K9AA/ATHP Z2 Power Cord KitYY1N1D5AAHP Z2 2nd serial port adapterYY141K8AA/ATHP Z2 Tower Dust FilterYY141L2AA/AT | | Note: Keyboard and Mouse are optional or add on features. | | | |
| HP DP Flex Port 2020 Y Y 141J7AA/AT HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y 141J8AA/AT HP HDMI Flex Port HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Y Y 20J15AA Option Kit Part Configured HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter Y Y 141K8AA/AT HP Z2 Tower Dust Filter | Flex Module (Rear IO) | | | Option Kit | Option Kit Part Number |
| HP Dual USB-A 3.2 Gen1 Flex Port 2020 Y Y 69D47AA/AT HP HDMI Flex Port HP USB-C 3.2 Gen2 Alt Flex Port 2020 Y Y 141K6AA/AT HP VGA Flex Port 2020 Y Y 141K7AA/AT HP Flex 1GbE Fiber LC Single Port Y Y 20J15AA Option Kit Part Configured HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter HP Z2 Tower Dust Filter | | HP 1GbE LAN Flex Port 2020 | Υ | Υ | 141J6AA/AT |
| HP HDMI Flex Port HP USB-C 3.2 Gen2 Alt Flex Port 2020 YYY141K6AA/AT HP VGA Flex Port 2020 YYY141K7AA/AT HP Flex 1GbE Fiber LC Single Port YYY20J15AA Other Hardware HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter YYY141L2AA/AT HP Z2 Tower Dust Filter | | HP DP Flex Port 2020 | Υ | Υ | 141J7AA/AT |
| HP USB-C 3.2 Gen2 Alt Flex Port 2020 YYY141K7AA/AT HP VGA Flex Port 2020 YYY141K7AA/AT HP Flex 1GbE Fiber LC Single Port YYY20J15AA Other Hardware Factory Configured Option Kit Part Number HP Single TBT3 wType C and USB4 PCle x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter YY141K8AA/AT HP Z2 Tower Dust Filter | | HP Dual USB-A 3.2 Gen1 Flex Port 2020 | Υ | Υ | 141J8AA/AT |
| HP VGA Flex Port 2020 HP Flex 1GbE Fiber LC Single Port The Flex 1GbE Fiber LC Single Port Factory Configured Option Kit Part Number HP Single TBT3 wType C and USB4 PCIe x4 Card HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter HP Z2 Tower Dust Filter | | HP HDMI Flex Port | Υ | Υ | 69D47AA/AT |
| HP Flex 1GbE Fiber LC Single Port Y Y 20J15AA Other Hardware Factory Configured Option Kit Part Number HP Single TBT3 wType C and USB4 PCIe x4 Card Y N N/A HP Z2 Internal Serial Port and PS/2 Port Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 1N1D5AA HP Z2 2nd serial port adapter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141L2AA/AT | | HP USB-C 3.2 Gen2 Alt Flex Port 2020 | Υ | Υ | 141K6AA/AT |
| Other Hardware Factory Configured Option Kit Part Number HP Single TBT3 wType C and USB4 PCIe x4 Card Y N N/A HP Z2 Internal Serial Port and PS/2 Port Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 1N1D5AA HP Z2 2nd serial port adapter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141L2AA/AT | | HP VGA Flex Port 2020 | Υ | Υ | 141K7AA/AT |
| Configured Option Kit Number HP Single TBT3 wType C and USB4 PCIe x4 Card Y N N/A HP Z2 Internal Serial Port and PS/2 Port Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 1N1D5AA HP Z2 2nd serial port adapter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141L2AA/AT | | HP Flex 1GbE Fiber LC Single Port | Υ | Υ | 20J15AA |
| HP Single TBT3 wType C and USB4 PCIe x4 Card Y N N/A HP Z2 Internal Serial Port and PS/2 Port Y Y 141K9AA/AT HP Z2 Power Cord Kit Y Y 1N1D5AA HP Z2 2nd serial port adapter Y Y 141K8AA/AT HP Z2 Tower Dust Filter Y Y 141L2AA/AT | Other Hardware | | - | Ontion Kit | Option Kit Part |
| HP Z2 Internal Serial Port and PS/2 Port HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter Y Y 141K9AA/AT Y Y 141K9AA/AT | | HP Single TBT3 wType C and USB4 PCIe x4 Card | _ | _ | |
| HP Z2 Power Cord Kit HP Z2 2nd serial port adapter HP Z2 Tower Dust Filter Y Y 1N1D5AA Y 141K8AA/AT | | | • | | |
| HP Z2 2nd serial port adapterYY141K8AA/ATHP Z2 Tower Dust FilterYY141L2AA/AT | | | • | | - |
| HP Z2 Tower Dust Filter Y Y 141L2AA/AT | | | - | | |
| · | | | • | | |
| | | HP Z2 Tower Dust Filter and bezel | Ү | Y | 141L3AA/AT |



HP Z2 G9 Single Type-C SuperSpeed USB 20Gbps Front Port

Υ

Υ

Υ

Υ

Υ

Υ

HP PCIe x1 Parallel Port Card

HP Z2 TWR Dual Front Fan Kit

N1M40AA

4M9X8AA/AT

4N007AA

Supported Components

HP Optical Bay HDD Mounting Bracket

Υ

Υ

NQ099AA

¹Available in Q3, 2021

| Racking and Physical Security | | Factory Configured | Option Kit | Option Kit Part Number |
|----------------------------------|---|-----------------------|------------|---------------------------|
| | HP Z2 Mini and Z2/Z4/Z6 TWR Depth Adjustable Fixed Rail Rack Kit | Υ | Υ | 2A8Y5AA |
| | HP Keyed Cable Lock | Υ | Υ | T1A62AA |
| | HP Master Keyed Cable Lock 10mm | Υ | Υ | T1A63AA |
| | HP Business PC Security Lock V3 Kit | Υ | Υ | 3XJ17AA |

| Software | | Factory Configured | Option Kit | Support Notes |
|----------|---|-----------------------|------------|------------------|
| | HP Performance Advisor | Υ | N | 1 |
| | HP PC Hardware Diagnostics UEFI (Windows OS only) | Υ | N | 2 |
| | HP PC Hardware Diagnostics Windows | | N | 3 |
| | HP Wolf Security | Υ | N | |
| | HP Notifications | Υ | N | |
| | HP Desktop Support Utility | Υ | N | |
| | HP Documentation | Υ | N | |
| | HP Image Assistant | N | N | |
| | HP Support Assistant | N | N | |
| | HP Quick Drop | Υ | N | |
| | myHP | Υ | N | |
| | HP Easy Clean | Υ | N | |
| | HP Smart Health | Υ | N | 7 |
| | Kingsoft WPS Office | Υ | N | 4 |
| | My Office | Υ | N | 5 |
| | Adobe Substance 3D Collection Plan | N | Υ | 6 |
| | WSL2/Ubuntu Data Science Stack | Υ | N | 7 |

Notes:

- 1. Supports, and preinstalled with Windows 10 only. Also available as a free download from http://www.hp.com/go/performanceadvisor
- 2. Windows OS only
- 3. Not available in Russia
- 4. Only available in China
- 5. Only available in Russia
- 6. Not available in China
- 7. Optional Software

Operating Systems

Windows 11 Pro - HP recommends Windows 11 Pro²

Windows 11 Home - HP recommends Windows 11 Pro²

Windows 10 Pro (available through downgrade rights from Windows 11 Pro) 1,2,3

Linux®-ready⁵

Ubuntu 20.04 LTS⁴



Supported Components

¹ Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

⁴ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

⁵For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux_hardware_matrix

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



Supported Components

HP BIOS

Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
 - -Power to expansion connectors / slots
 - -Most Wake events other than power buttons and WOL(Wake on LAN supported by embedded Lan controller under S4/S5 Maximum Power Saving Enabled)
 - -USB charging ports

HP Sure Start Gen7 Start

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

Note: HP Sure Start Gen7 is available on HP Workstation products equipped with Intel® 12th generation processors.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Software

HP Support Assistant 14

HP Image Assistant

HP Desktop Support Utility

HP Documentation

HP Notifications

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Performance Advisor¹

mvHP

HP QuickDrop¹⁹

HP Easy Clean²⁰

HP Smart Health²¹

WSL/Ubuntu Data Science Stack

HP Privacy Settings

Touchpoint Customizer for Commercial

Manageability Features



Supported Components

HP Driver Packs²

HP UWP Pack

HP System Software Manager (SSM)

HP Manageability Integration Kit Gen43

HP Smart Support⁵

HP Client Catalog (download)

HP Image Assistant (download)

HP Cloud Recovery

HP Client Management Script Library (download)

HP BIOSphere Gen6 13

Client Security Software

HP Client Security Suite Gen7⁴ including: (including Credential Manager, HP Password Manager⁶, HP Spare Key) HP Power On Authentication Microsoft Defender⁷

Security Management

HP Secure Erase 16

HP Wolf Pro Security Edition (optional) 18

HP Wolf Security for Business²² Includes:

HP Sure Click¹¹

HP Sure Sense¹²

HP Sure Run Gen59

HP Sure Recover Gen4 10

HP Sure Start Gen78

HP Tamper Lock

HP Sure Admin 17

HP Client Security Manager Gen 74

- ¹ HP Performance Advisor Software HP Performance Advisor is ready to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: http://hp.com/PerformanceAdvisor
- ² HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- ³ HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- ⁴ HP Client Security Manager Gen7 requires Windows and is available on the select HP PCs.
- ⁵ HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
- ⁶ HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- ⁷ Microsoft Defender Opt in and internet connection required for updates.
- ⁸ HP Sure Start Gen 7 is available on select HP PCs and workstations. See product specifications for availability.
- ⁹ HP Sure Run Gen5 is available on select Windows 11 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors
- ¹⁰ HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module
- 11 HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.



Supported Components

- ¹² HP Sure Sense requires Windows 11 Pro or Enterprise and supports Microsoft Internet Explorer, Google Chrome™, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
- ¹³ HP BIOSphere Gen6 features may vary depending on the platform and configurations.
- ¹⁴ HP Support Assistant requires Windows and Internet access.
- ¹⁶ Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane.
- ¹⁷ HP Sure Admin requires Windows 11, HP BIOS, HP Manageability Integration Kit from
- http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- ¹⁸ HP Wolf Pro Security Edition is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-
- en/document/ish_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.
- ¹⁹ HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
- ²⁰ HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.
- ²¹ HP Smart Health automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
- ²² HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features



System Technical Specifications

System Board

System Board Form

Factor Customized PCB 36.056 x 25.130 mm (14.197 x 9.894 inch)

Processor Socket Single LGA-1700

CPU Bus Speed DMI Gen4

Chipset Intel® PCH W680
Super I/O Controller Nuvoton SIO21

Memory Expansion Slots 4 DDR5 memory slots

Memory Type Supported DDR5, UDIMM (Unbuffered), ECC& non-ECC

Memory Modes Non-Interleaved for single channel. Interleaved when both channels are populated.

Memory Speed Supported 3600MT/s to 4400MT/s DDR5, dependent on memory configuration¹

¹Though the memory modules can run up to 4800MHz, the current platform will only be able to support the maximum memory speed of 4400MHz.

The system speed will be determined by a number of key factors:

Module Description of configuration Max Memory Speed (Actual Memory Configuration speed is dependent on CPU)

Single DIMM per Configurations that contain only one or two 4400MHz

channel DIMM modules with DIMMs only in the black slots

Two single ranked Configurations with 3 or 4 single ranked DIMMs 4000MHz

DIMMs in a channel (8GB and 16GB) installed in a system

Two dual ranked Configurations with 3 or 4 dual ranked DIMMs 3600MHz

DIMMs in a channel (32GB) installed in a system

Memory Protection ECC available on data

SATA

Maximum Memory 128GB

riaxilliulii rielliul y 1200

Memory Configuration

Supported Interfaces

8GB, 16GB and 32GB non-ECC, 16GB and 32GB ECC unbuffered DIMMs are supported. ECC and non-ECC

(Supported) memory DIMMs cannot be mixed in the same system

PCI Express Connectors (1) PCI Express Gen5 slot x16 mechanical/ x16 electrical (full height, full length)

(1) PCI Express Gen3 slot x4 mechanical/ x1 electrical (full height, full length, open-ended)

(1) PCI Express Gen3 slot x16 mechanical/x4 electrical (full height, full length)

(1) PCI Express Gen3 slot x4 mechanical/ x4 electrical (full height, full length, open-ended)

(1) M.2 2280 Storage (PCIe Gen4 x4) (1) M.2 2280 Storage (PCIe Gen4 x4) (1) M.2 2280 Storage (PCIe Gen4 x4)

(1) M.2 2230 WLAN (PCIe Gen3 x1+ Intel CNVi)

NOTE: The PCIe Gen5 x16 slot has validated and passed PCI-SIG electrical compliance test

ONLY. HP does not guarantee and support any PCIe Gen5 cards in the market.

Integrated (4) Serial ATA interfaces (6Gb/s SATA).

RAID 0 and 1 supported. Factory integrated RAID for

Microsoft Windows only.

Integrated Graphics Intel® UHD Graphics 730 (on Core i5-12400/i3-12300/i3-

12100) processors); Intel® UHD Graphics 770 (on Core

i5/i7/i9 processors);

Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics

display.



System Technical Specifications

Support for Microsoft DirectX 12, OpenGL 4.6 and OpenCL 3.0

on Intel® UHD Graphics 730/770;

Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics

display.

2 DP 1.4 graphics ports integrated in motherboard; Supports

up to three simultaneous displays across

DisplayPort*/HDMI*/DVI outputs.

Max. resolution supported on onboard DP 1.4/HBR2 ports:

4096x2304 @ 60Hz, 24bpp

Max. resolution supported on FlexIO DP 1.4/HBR3 port:

5120x3200 @60Hz, 24bpp

Network Controller Integrated Ethernet PHY Connection I219LM. Management

capabilities: WOL, PXE 2.1 and AMT 16

Serial 1 internal header (requires optional Serial Port and PS/2

Combo Kit with PCIe bracket)

2nd Serial 1 internal header(requires optional Serial Port Adapter Kit)

supports up to 5V/2.1A);

2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C® SuperSpeed USB 20Gbps signaling rate port

2 Type-A SuperSpeed USB 10Gbps signaling rate port (charge

(optional, charge supports up to 5V/3A)

Rear 3 High-speed USB 480Mbps signaling rate port; 1 Type-A

SuperSpeed USB 5Gbps signaling rate port; 2 Type-A

SuperSpeed USB 10Gbps signaling rate port;

Flex I/O option:

1 SuperSpeed USB Type-C[®] 10Gbps signaling rate (Power Delivery 15W, Alt Mode DisplayPort); 1 Dual SuperSpeed USB

Type-A 5Gbps signaling rate

Internal 1 High-speed USB 480Mbps signaling rate header for SD Card

Reader

HD Integrated Audio Realtek ALC3205

Front

Flash ROM Yes
CPU Fan Header Yes
Memory Fan Header None

Chassis Fan Header 1 Rear System Chassis Fan Header, 1 Graphic chassis Fan Header.

Front PCI Fan Header None

Front Control

USB Connector(s)

Panel/Speaker Header Yes

CMOS Battery Holder -

Lithium Yes

Integrated Trusted Integrated TPM 2.0 (Infineon SLB9672)

Platform Module Convertible to FIPS 140-2 Certified mode through firmware v15.21

Power Supply Headers Yes
Power Switch, Power LED
& Hard Drive LED Header Yes
Clear Password Jumper None

Keyboard/Mouse USB or PS/2 (option)

Power Supply 700W EPA92, 500W EPA90, 450W EPA90 and 350W EPA92

System Technical Specifications

¹Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 10 Professional 64 bit, Red Hat Linux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.

²M.2 storage supports compatible devices up to 80mm



System Technical Specifications

| System Configuratio | ns | | | | | | |
|-----------------------|-------------------------|----------------|-----------------|----------------|-----------------|----------------|-----------------|
| Example Configuration | Processor Info | Core i5-1250 | 0,6C 3.0G 65W | | | | |
| #1 | Memory Info | 2 x 8G DDR5 4 | 1800 UDIMM NI | ECC | | | |
| | Graphics Info | NVIDIA T400 | 4GB | | | | |
| | Disks/Optical/Floppy | 512GB SSD Z | Turbo | | | | |
| | PSU | 350W | | | | | |
| | Other | NA | | | | | |
| Energy Consumption | | 115 | VAC | 230 | VAC | 100 | VAC |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows long Idle (S0) | 17. | 866 | 17. | 912 | 17. | 804 |
| | Windows short Idle (S0) | 18. | 926 | 19. | 024 | 18. | 883 |
| | Windows Busy Typ (S0) | 160 | .167 | 155 | .973 | 161 | .10 |
| | Windows Busy Max (S0) | 192 | .557 | 187 | .067 | 193 | .063 |
| | Sleep (S3) | 1.367 | 1.259 | 1.401 | 1.367 | 1.259 | 1.401 |
| | Off (S5) | 0.555 | 0.552 | 0.561 | 0.555 | 0.552 | 0.561 |
| | Zero Power Mode (EuP) | 0.1 | 71 | 0.1 | 73 | 0.1 | 68 |
| | ' | ' | | | | | |
| Heat Dissipation | | 115 VAC | | 230 VAC | | 100 VAC | |
| (Btu/hr) | | LAN | LAN | LAN | LAN | LAN | LAN |
| | | Enabled | Disabled | Enabled | Disabled | Enabled | Disabled |
| | Windows Idle (S0) | | 959 | 1 | 116 | 60. | |
| | Windows short Idle (S0) | 64.576 | | | .91 | | 429 |
| | Windows Busy Typ (S0) | 546.489 | | 532 | | l l | .707 |
| | Windows Busy Max (S0) | | .003 | 638 | | 658.732 | |
| | Sleep (S3) | 4.664 | 4.296 | 4.78 | 4.664 | 4.296 | 4.78 |
| | Off (S5) | 1.894 | 1.883 | 1.914 | 1.894 | 1.883 | 1.914 |
| | Zero Power Mode (EuP) | | 583 | | 59 | 0.5 | 573 |
| Example Configuration | Processor Info | | 0,12C 2.1G 65V | | | | |
| #2 | Memory Info | | 4800 UDIMM N | NECC | | | |
| | Graphics Info | NVIDIA T1000 | | | | | |
| | Disks/Optical/Floppy | 512GB SSD Z | Turbo | | | | |
| | PSU | 450W | | | | | |
| | Other | NA | | 1 | | ı | |
| Energy Consumption | | | VAC | 1 | VAC | | VAC |
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows long Idle (S0) | 20. | 169 | 20. | 335 | 20. | 087 |
| | Windows short Idle (S0) | 21. | 222 | 21. | 547 | 21. | 195 |
| | Windows Busy Typ (S0) | 119 | 9.48 | 117 | .953 | 120 | .406 |
| | Windows Busy Max (S0) | 157 | 7.13 | 155 | 5.03 | 157 | .833 |
| | Sleep (S3) | 1.575 | 1.461 | 1.582 | 1.575 | 1.461 | 1.582 |
| | Off (S5) | 0.944 | 0.941 | 0.952 | 0.944 | 0.941 | 0.952 |
| | Zero Power Mode (EuP) | 0.3 | 204 | 0.7 | 207 | 0.2 | 202 |



System Technical Specifications

| Heat Dissipation | | 115 | VAC | 230 | VAC | 100 VAC | |
|-----------------------|--------------------------|----------------------------|--------------|---------|----------|---------|----------|
| (Btu/hr) | | LAN | LAN | LAN | LAN | LAN | LAN |
| | | Enabled | Disabled | Enabled | Disabled | Enabled | Disabled |
| | Windows Idle (S0) | 68. | 817 | 69. | 383 | 68. | 537 |
| | Windows short Idle (S0) | 72. | 409 | 73. | 518 | 72. | 317 |
| | Windows Busy Typ (S0) | 407 | .666 | 402 | .457 | 410 | .824 |
| | Windows Busy Max (S0) | 536 | .128 | 528. | .962 | 538 | .527 |
| | Sleep (S3) | 5.374 | 4.985 | 5.398 | 5.374 | 4.985 | 5.398 |
| | Off (S5) | 3.221 | 3.211 | 3.248 | 3.221 | 3.211 | 3.248 |
| | Zero Power Mode (EuP) | 0.696 0.706 0.689 | | | | | |
| Example Configuration | Processor Info | Core i9-12900,16C 2.4G 65W | | | | | |
| #3 | Memory Info | 2 x 16G DDR5 | 4800 UDIMM E | :CC | | | |
| | Graphics Info | NVIDIA RTX AZ | 2000 | | | | |
| | Disks/Optical/Floppy | 512GB SSD Z | Turbo | | | | |
| | PSU | 450W | | | | | |
| | Other | NA | | | | | |
| Energy Consumption | | 115 | VAC | 230 VAC | | 100 VAC | |
| (Watts) | | LAN | LAN | LAN | LAN | LAN | LAN |
| | | Enabled | Disabled | Enabled | Disabled | Enabled | Disabled |
| | Windows long Idle (S0) | 22. | 555 | 23. | 324 | 22. | 484 |
| | Windows short Idle (S0) | 23. | 414 | 24. | 656 | 23. | 397 |
| | Windows Busy Typ (S0) | 159. | .883 | 156 | .853 | 161 | .463 |
| | Windows Busy Max (S0) | 189 | .99 | 185 | 5.89 | 190 | .127 |
| | Sleep (S3) | 1.585 | 1.492 | 1.694 | 1.585 | 1.492 | 1.694 |
| | Off (S5) | 0.952 | 0.95 | 1.083 | 0.952 | 0.95 | 1.083 |
| | Zero Power Mode (EuP) | 0.21 | | 0.217 | | 0.198 | |
| | zero i ower riode (zur / | - | | | | 1 | |

| Heat Dissipation | | 115 | 115 VAC | | 230 VAC | | VAC | |
|------------------|-------------------------|----------------|-----------------|----------------|-----------------|----------------|-----------------|--|
| (Btu/hr) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | |
| | Windows Idle (S0) | 76. | 958 | 79. | 581 | 76. | 715 | |
| | Windows short Idle (S0) | 79. | 889 | 84. | 126 | 79. | 79.831 | |
| | Windows Busy Typ (S0) | 545 | .522 | 535 | .184 | 550 | .913 | |
| | Windows Busy Max (S0) | 648 | .246 | 634 | .257 | 648 | .712 | |
| | Sleep (S3) | 5.408 | 5.091 | 5.78 | 5.408 | 5.091 | 5.78 | |
| | Off (S5) | 3.248 | 3.241 | 3.695 | 3.248 | 3.241 | 3.695 | |
| | Zero Power Mode (EuP) | 0.717 | | 0.74 | | 0.676 | | |

| Example Configuration | Processor Info | Core i7-12700K,12C 3.6G 125W |
|-----------------------|----------------------|------------------------------|
| #4 | Memory Info | 4 x 16G DDR5 4800 UDIMM NECC |
| | Graphics Info | NVIDIA RTX A4000 |
| | Disks/Optical/Floppy | 1T SSD Z Turbo |
| | PSU | 700W |
| | Other | NA |



System Technical Specifications

| Energy Consumption | | 115 | VAC | 230 VAC | | 100 VAC | |
|---------------------------|-------------------------|---------------|--------------|-------------|--------------|-------------|--------------|
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows long Idle (S0) | 22. | 551 | 22.964 | | 22.486 | |
| | Windows short Idle (S0) | 23.911 24.168 | | 23.7 | 23.749 | | |
| | Windows Busy Typ (S0) | 272 | 2.74 | 267. | .963 | 274.65 | |
| | Windows Busy Max (S0) | 322 | .833 | 316 | 5.03 | 323. | |
| | Sleep (S3) | 1.994 | 1.892 | 1.997 | 1.994 | 1.892 | 1.997 |
| | Off (S5) | 0.653 | 0.641 | 0.666 | 0.653 | 0.641 | 0.666 |
| | Zero Power Mode (EuP) | 0.215 | | 0.217 | | 0.212 | |

| Heat Dissipation | | 115 | VAC | 230 | VAC | 100 | VAC | |
|-------------------------|-------------------------|-------------|--------------|-------------|--------------|-------------|--------------|--|
| (Btu/hr) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | |
| | Windows Idle (S0) | 76. | 944 | 78.3 | 353 | 76. | 6.722 | |
| | Windows short Idle (S0) | 81. | 584 | 82.4 | 461 | 81. | 81.032 | |
| | Windows Busy Typ (S0) | 930 | .589 | 914. | 291 | 937.106 | | |
| | Windows Busy Max (S0) | 1101 | .507 | 1078 | .294 | 1103 | .327 | |
| | Sleep (S3) | 6.804 | 6.456 | 6.814 | 6.804 | 6.456 | 6.814 | |
| | Off (S5) | 2.228 | 2.187 | 2.272 | 2.228 | 2.187 | 2.272 | |
| | Zero Power Mode (EuP) | 0.7 | '34 | 0.7 | 74 | 0.7 | 0.723 | |

| Example Configuration | Processor Info | Core i9-12900K,16C 3.2G 125W |
|-----------------------|----------------------|------------------------------|
| #5 | Memory Info | 4 x 32G DDR5 4800 UDIMM ECC |
| 1 | Graphics Info | NVIDIA RTX A5000 |
| 1 | Disks/Optical/Floppy | 1T SSD Z Turbo |
| | PSU | 700W |
| | Other | NA |

| Energy Consumption | | 115 VAC | | 230 VAC | | 100 VAC | | |
|---------------------------|-------------------------|---------------|--------------|-------------|--------------|-------------|--------------|--|
| (Watts) | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled | |
| | Windows long Idle (S0) | 24. | 24.038 | | 24.681 | | 23.994 | |
| | Windows short Idle (S0) | 25.764 25.958 | | 25.621 | | | | |
| | Windows Busy Typ (S0) | 465 | 5.05 | 459 | 9.71 | 468 | 468.377 | |
| | Windows Busy Max (S0) | 467 | .623 | 438 | .733 | 474 | 1.68 | |
| | Sleep (S3) | 2.261 | 2.148 | 2.273 | 2.261 | 2.148 | 2.273 | |
| | Off (S5) | 0.772 | 0.659 | 0.777 | 0.772 | 0.659 | 0.777 | |
| | Zero Power Mode (EuP) | 0.318 | | 0.319 | | 0.315 | | |

| Heat Dissipation | | 115 VAC | | 230 VAC | | 100 VAC | |
|------------------|-------------------------|--------------------------|------|-------------|--------------|-------------|--------------|
| (Btu/hr) | | LAN Enabled LAN Disabled | | LAN Enabled | LAN Disabled | LAN Enabled | LAN Disabled |
| | Windows Idle (S0) | 82.018 | | 84.212 | | 81.868 | |
| | Windows short Idle (S0) | lle (S0) 87.907 | | 88.569 | | 87.419 | |
| | Windows Busy Typ (S0) | 158 | 6.75 | 1568 | 3.531 | 1598 | 3.101 |
| | Windows Busy Max (S0) | 1595.531 1496.958 | | 1619 | 1619.608 | | |
| | Sleep (S3) | 7.715 7.329 | | 7.755 | 7.715 | 7.329 | 7.755 |

System Technical Specifications

| Off (S5) | 2.634 | 2.249 | 2.651 | 2.634 | 2.249 | 2.651 |
|-----------------------|-------|-------|-------|-------|-------|-------|
| Zero Power Mode (EuP) | 1.0 | 85 | 1.0 | 88 | 1.0 | 75 |

NOTE: The Power Supply Efficiency report may be found at the following links:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2



System Technical Specifications

Operating Voltage Range 90-269 VAC **Rated Voltage Range** 100-240 VAC **Rated Line Frequency** 50-60 Hz **Operating Line Frequency** 47-63 Hz

Range

Rated Input Current 8.2A @ 100-240V

Heat Dissipation Typical: 1598.101 btu/hr (402.984 kcal/hr)

Maximum: 1619.608 btu/hr (408.407 kcal/hr)

Yes, with Wake-on-LAN disabled: <1W in S4/S5 - Power Off

ENERGY STAR® certified

(Config Dependent)

CECP Compliant @ 220V Yes

FEMP Standby Power

Built-in Self Test (BIST)

Compliant

Yes

Yes

LED

Surge Tolerant Full Ranging Power Supply (withstands power surges

up to 2000V)

Hood Lock Header Yes ErP Lot 6- Tier 1 Yes Compliance @ 230V (<1W

in S5 - Power Off)

ErP Lot 6- Tier 2 Yes

Compliance @ 230V (<0.5W in S5 - Power Off)

| Declared Noise Emissions | (Entry-level, Mid-level, ar | nd High-end configurations; tested on flo | or) | | | |
|-------------------------------------|---|--|---|--|--|--|
| System Configuration | Processor Info | Intel® CPU Core i5-12400 6C LGA 2.50G 18 MB 65W (Intel - Alder Lake-S) | | | | |
| (Entry level) | Memory Info | 32GB 4800 SK hynix memory | | | | |
| | Graphics Info | Intel® UHD | | | | |
| | Disks/Optical | 1*2TB Samsung M.2 SSD | | | | |
| | Power Supply | Chicony 700W EPA92 | | | | |
| Declared Noise Emissions | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) | | | |
| | Idle | 3.36 | 14.9 | | | |
| | Hard drive Operating (Drive Random Seek) | 3.78 | 20.3 | | | |
| | Hard drive Operating (Active mode) | 3.45 | 17.7 | | | |
| System Configuration (Mid-level) | Processor Info | Intel® CPU Core i9-12900 16C LGA 2.40G 30 MB 65W ECC (Int S) | | | | |
| | Memory Info | 4* 32GB 4800 SK hynix memory | | | | |
| | Graphics Info | NVIDIA® RTX A5000 | | | | |
| | Disks/Optical | 3*2TB Samsung M.2 SSD; 2*WD 2TB 7200RPM SATA HDD | | | | |
| | Power Supply | Chicony 700W EPA92 | Chicony 700W EPA92 | | | |



System Technical Specifications

| idl | | | (LpAm, decibels) | | | |
|--------------------------|---|---|---|--|--|--|
| | lle | 3.59 | 18.5 | | | |
| | ard drive Operating Orive Random Seek) | 3.82 | 20.1 | | | |
| | ard drive Operating Active mode) | 3.97 | 23.6 | | | |
| -, | rocessor Info | Intel® Core i9-12900K 16C 3.20G LGA 30 MB 125W ECC (Intel - Alder Lake-S) | | | | |
| (High-end) Me | emory Info | 4* 32GB 4800 SK hynix memory | | | | |
| Gra | raphics Info | NVIDIA® RTX A5000 | | | | |
| Dis | isks/Optical | 3*2TB Samsung M.2 SSD; 2*WD 2TB 7200RPM SATA HDD | | | | |
| Po | ower Supply | Chicony 700W EPA92 | | | | |
| Declared Noise Emissions | | Sound Power (LWAd, bels) | Deskside Sound Pressure (LpAm, decibels) | | | |
| idl | lle | 3.58 | 18.2 | | | |
| | ard drive Operating Orive Random Seek) | 3.78 | 20 | | | |
| I I | ard drive Operating Active mode) | 4.05 | 20.9 | | | |

Environmental Requirements

Temperature Operating: 5° to 35° C (40° to 95° F)

Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

Humidity Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Cooling for details.

Dynamic Shock

Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20q

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Cooling Above 1524 m (5,000 feet) altitude, the maximum operating temperature

is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation.

up to 3048 m (10,000 feet)

Physical Security and Serviceability

Access Panel Tool-less

Includes support information

Optical Drive Tool-less, except for Screw-In carrier

Hard Drives Tool-less, except for 2.5" bay

Expansion Cards Tool-less



System Technical Specifications

Processor Socket Tool-less, except for the processor heatsink **Blue User Touch Points** Yes, on tool-less internal chassis mechanisms

Color-coordinated Cables Yes

and Connectors

Memory Tool-less **System Board** Screw-In

Padlock Support Yes (optional): Locks side cover and secures chassis from theft

0.22-in diameter padlock loop at rear of system

Cable Lock Support Yes. Kensington Cable Lock (optional): Locks side cover and secures chassis from theft

3 mm x 7 mm slot at rear of system

Threaded feature at rear of system

Universal Chassis Clamp

Lock Support

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows

multiple units to be chained together when used with optional cable

Solenoid Lock and Hood

Sensor

Yes (optional)

The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through

software and a password. You can also lock and unlock the chassis remotely over the network. The

Sensor Kit detects when the access panel has been removed.

Rear Port Control Cover

CPUs and Heatsinks A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be

removed. CPU removal is tool-less

Internal Speaker

70mm x 70mm x 25mm 4-wire PWM (non-serviceable) **Power Supply Fans**

Access Panel Key Lock No

Integrated Chassis

Handles

Rear Recessed Handle

Power Supply Requires T15 Torx or flat blade screwdriver

Yes, rear (all), middle (optional), front (full-length cards with extender) **PCI Card Retention**

Service, Support, and Warranty

On-site Warranty and Service¹: Three-years, limited warranty and service offering delivers on-site, next business-day² service for parts and labor and includes free telephone support³ 8am - 5pm. Global coverage² ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at:

http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.

BIOS

BIOS 64-bit Services BIOS supports 64-bit Operating systems only.

Full BIOS support for PCI Express through industry standard interfaces. PCI 3.0 Support

ATAPI ATAPI Removable Media Device BIOS Specification Version 1.0.



System Technical Specifications

BBS BIOS Boot Specification v1.01.(Not support)

WMI Support WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is

fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM)

and WBEM specifications.

BIOS Boot Spec 1.01+

Provides more control over how and from what devices the workstation will boot. (Not Support)

BIOS Power On ROM Based Computer Users can define a specific date and time for the system to power on.

Setup Utility (F10)

Review and customize system configuration settings controlled by the BIOS.

Flash Recovery with

System/Emergency ROM Recovers system BIOS in corrupted Flash ROM.

Video **Replicated Setup**

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt).

BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed

without entering Computer Configuration Utility (F10 Setup).

SMBIOS Boot Control System Management BIOS 3.4, for system management information. Disables the ability to boot from removable media on supported devices.

Memory Change Alert Thermal Alert

Alerts management console if memory is removed or changed. Monitors the temperature state within the chassis. Three modes:

NORMAL - normal temperature ranges.

ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid

shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer

without warning before hardware component damage occurs.

Remote ROM Flash

Provides secure, fail-safe ROM image management from a central network console.

ACPI (Advanced Management Interface)

Allows the system to enter and resume from low power modes (sleep states). Configuration and Power Enables an operating system to control system power consumption based on the dynamic workload.

Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 6.0 for full compatibility with 64-bit operating systems.

Ownership Tag

A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.

Shutdown

Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location.

Instantly Available PC

(Suspend to RAM - ACPI sleep state S3)

Allows for very low power consumption with quick resume time.

Remote System

Installation via F12 (PXE operating system. 2.1) (Remote Boot from

Server)

Allows a new or existing system to boot over the network and download software, including the

ROM revision levels

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup), Version is available through an industry standard interface (SMBIOS and WMI) so that management SW

applications can use and report this information.

System board revision level

Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.

Start-up Diagnostics (Power-on Self-Test) Assesses system health at boot time with selectable levels of testing.

Auto Setup when new hardware installed

System automatically detects addition of new hardware.

Keyboard-less Operation The system can be booted without a keyboard.

Localized ROM Setup

Common BIOS image supports System Configuration Utility (F10 Setup) menus in 15 languages with

local keyboard mappings.

Asset Tag

The user or MIS to set a unique tag string in non-volatile memory.

Per-slot Control Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.



System Technical Specifications

Adaptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics.

Pre-boot Diagnostics UEFI Specification

PMM

(Pre-video) critical errors are reported via beeps and blinks on the power LED.

Revision 2.7

ACPI Advanced Configuration and Power Management Interface, Version 6.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b **CD Boot** "El Torito" Bootable CD-ROM Format Specification Version 1.0

EDD Enhanced Disk Drive Specification Version 1.1

BIOS Enhanced Disk Drive Specification Version 3.0(Not support)

EHCI Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0

PCI PCI Local Bus Specification, Revision 2.3

> PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7

PCI Express Base Specification, Revision 2.0 **PCI Express**

> PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Ready POST Memory Manager Specification, Version 1.01

Serial ATA Specification, Revision 1.0a **SATA**

> Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD JEDEC JESD300-5

TPM Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9670).

Common Criteria EAL4+ certified.

FIPS 140-2 Certification TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

Universal Host Controller Interface Design Guide, Revision 1.1 UHCI

USB Universal Serial Bus Revision 1.1 Specification

> Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification Universal Serial Bus Revision 3.2 Specification

SMBIOS System Management BIOS Reference Specification, Version 3.4

External BIOS simulator found at: http://csrsml.itcs.hp.com/

Social and Environmental Responsibility

& Declarations

Eco-Label Certifications This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT[®] Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- TCO Certified
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label*



System Technical Specifications

Sustainable Impact Specifications

- Ocean-bound plastic in System FAN, CPU FAN and Speaker
- 50% post-consumer recycled plastic
- Low halogen
- Outside Box and corrugated cushions are 100% sustainably sourced and recyclable
- Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable
- Bulk packaging available

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)

| method) | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 50Hz |
|------------------------------|--------------|--------------|--------------|
| Normal Operation (Sort idle) | 34.16 W | 34.01 W | 34.39 W |
| Normal Operation (Long idle) | 32.77 W | 32.74 W | 33.15 W |
| Sleep | 2.57 W | 2.54 W | 2.57 W |
| Off | 0.67 W | 0.68 W | 0.67 W |

Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

| Heat Dissipation* | 115VAC, 60Hz | 230VAC, 50Hz | 100VAC, 50Hz |
|-------------------------------|--------------|--------------|--------------|
| Normal Operation (Short idle) | 116.8 BTU/hr | 116.3 BTU/hr | 117.6 BTU/hr |
| Normal Operation (Long idle) | 112.1 BTU/hr | 112 BTU/hr | 113.4 BTU/hr |
| Sleep | 8.8 BTU/hr | 8.7 BTU/hr | 8.8 BTU/hr |
| Off | 2.3 BTU/hr | 2.3 BTU/hr | 2.3 BTU/hr |

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Fmissions

| (in accordance with ISO 7779 and ISO 9296) | Sound Power (L _{WAd} , bels) | Sound Pressure (L _{pAm} , decibels) |
|---|--|---|
| Typically Configured – Idle | 3.36 | 14.9 |
| Fixed Disk – Random writes | 3.78 | 20.3 |
| Optical Drive – Sequential reads | 5.00 | 33.4 |

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the



System Technical Specifications

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery in this product complies with EU Directive 2006/66/EC

Battery size: CR2032 (coin cell) Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40 ppm by weight

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive
 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 94.8% recycle-able when properly disposed of at end of life.

Packaging Materials

External: PAPER/Corrugated 1214 g

PAPER/Molded Pulp 890 g PLASTIC/Polyethylene low 40 g

density - LDPE

The plastic packaging material contains at least 0.0% recycled content.

The corrugated paper packaging materials contains at least 62.5% recycled content.

RoHS Compliance

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

Asbestos

Internal:

- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium



System Technical Specifications

- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- · Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.



System Technical Specifications

HP, Inc. Corporate Environmental Information For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

footnotes

- Percentage of ocean-bound plastic contained in each component varies by product
- Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.
- External power supplies, WWAN modules, power cords, cables and peripherals excluded.
- 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
- Fiber cushions made from 100% recycled wood fiber and organic materials.



Technical Specifications - Processors

| Name | Cores | Clock Speed (GHz) | Inread | Cache (MB) | Memory Speed (MT/s) | Hyper- Threading | Integrated Graphics | Intel® Turbo Boost Technology³ | Intel® vPro® | 16GB Intel® Optane™ memory² | TDP (W) |
|--------------------------------------|-------|-------------------------|--------|---------------|---------------------------|---------------------|----------------------------|--------------------------------------|--------------|--------------------------------------|------------|
| Intel® Core™ i9- 12900K Processor | 16 | 3.2 | 24 | 30 | 4800 | Y | Intel® UHD Graphics 770 | 5.2 | Y | N | 125 |
| Intel® Core™ i9- 12900 Processor | 16 | 2.1 | 24 | 30 | 4800 | Y | Intel® UHD Graphics 770 | 5.1 | Y | N | 65 |
| Intel® Core™ i7- 12700K Processor | 12 | 3.6 | 20 | 25 | 4800 | Y | Intel® UHD Graphics 770 | 5.0 | Y | N | 125 |
| Intel® Core™ i7- 12700 Processor | 12 | 2.1 | 20 | 25 | 4800 | Y | Intel® UHD Graphics 770 | 4.9 | Y | N | 65 |
| Intel® Core™ i5- 12600K Processor | 10 | 3.7 | 16 | 20 | 4800 | Y | Intel® UHD Graphics 770 | 4.9 | Y | N | 125 |
| Intel® Core™ i5- 12600 processor | 6 | 3.3 | 12 | 18 | 4800 | Y | Intel® UHD Graphics 770 | 4.8 | Y | N | 65 |
| Intel® Core™ i5- 12500 processor | 6 | 3.0 | 12 | 18 | 4800 | Y | Intel® UHD Graphics 770 | 4.6 | Y | N | 65 |
| Intel® Core™ i5- 12400 processor | 6 | 2.5 | 12 | 18 | 4800 | Y | Intel® UHD Graphics 730 | 4.4 | N/A | N | 65 |
| Intel® Core™ i3- 12300 processor | 4 | 3.5 | 8 | 12 | 4800 | Y | Intel® UHD Graphics 730 | 4.4 | N/A | N | 60 |
| Intel® Core™ i3- 12100 processor | 4 | 3.3 | 8 | 12 | 4800 | Y | Intel® UHD Graphics 730 | 4.3 | N/A | N | 60 |

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Note: ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12500 processors

² Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

³ Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

⁴ Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

Technical Specifications - Hard Drives

| SATA Hard Drives for H | P |
|------------------------|---|
| Workstations | |

500GB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity500GBProtocolSATAForm Factor3.5"ControllerAHCI

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600MB/s *

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

32MB

Seek Time (typical reads,
includes controller
overhead, includingSingle Track
Average2 ms *11 ms *Full Stroke21 ms *

settling)

Buffer

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

| 1TB | SAT | A 7 | 200 | rpm |
|-----|-------|-----|-----|-----|
| 6Gb | /s 3. | 5" | HDD | |

| Capacity | 1TB |
|-------------|---------------|
| Protocol | SATA |
| Form Factor | 3.5" |
| Controller | AHCI |
| Height | 1 in; 2.54 cm |

Width Media Diameter

Physical Size 4 in; 10.17 cm

3.5 in: 8.9 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Up to 600 MB/s *

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads,
includes controller
overhead, including
antition)Single Track
Average2 ms *11 ms *Full Stroke21 ms *

settling)

Rotational Speed 7,200 rpm

Logical Blocks 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

2TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 2TB
Protocol SATA
Form Factor 3.5"
Controller AHCI



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

Annualized Failure Rate

(based on Rated POH) <0.62% Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s *

Buffer 64MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2.0 ms *Average
Full Stroke11 ms *21 ms *

Rotational Speed 7,200 rpm Logical Blocks 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class) Capacity 1TB
Height 1 in; 2.54 cm
Protocol SATA
Form Factor 3.5"
Controller AHCI
Reliability 2.0M hours
Rated Power On Hours 8760/yr

Annualized Failure Rate

(based on Rated POH) <0.62%

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Up to 600MB/s *

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Buffer 128MB

Seek Time (typical reads, includes controller overhead, including settling)

Single Track 0.32ms*

Average 7.45ms*

Full Stroke 14.2ms*

Rotational Speed 7,200 rpm

Operating Temperature 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s*

Sequential Write up to 226MB/s*

Enterprise Class Features High Reliability

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Capacity 2TB



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

SATA **Protocol Form Factor** 3.5" **Controller AHCI** Reliability (MTBF) 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** < 0.62%

(based on Rated POH) Rated for 24/7/365

Operation

Physical Size (Height) 1 in; 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in: 8.9 cm

2TB SATA 7200 rpm 6Gb/s 3.5" HDD Interface (Enterprise Class)

Rate (Maximum)

Synchronous Transfer

128MB

Seek Time (typical reads, **Single Track** 0.7ms* includes controller Average 8.5ms* overhead, including **Full Stroke** 15.7ms* settling)

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s* **Sequential Write** up to 226MB/s*

Up to 600MB/s*

Serial ATA (6Gb/s), NCQ enabled

Enterprise Class Features High Reliability

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

Capacity 4TB SATA Protocol 3.5" Form Factor Controller AHCI Reliability 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** <0.62%

(based on Rated POH) Rated for 24/7/365

Operation

Physical Size (Height) 1 in; 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Up to 600MB/s*

Synchronous Transfer

Rate (Maximum)

Buffer 256MB



^{*}Actual performance may vary.

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.7ms*Average
Full Stroke8.5ms*15.7ms*

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s*
Sequential Write up to 226MB/s*

Enterprise Class Features High Reliability

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

| 8TB SATA 7200 rpm |
|--------------------|
| 6Gb/s 3.5" HDD |
| (Enterprise Class) |

Capacity 8TB
Protocol SATA
Form Factor 3.5"
Controller AHCI
Reliability 2.0M hours

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Up to 600MB/s [1]

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 256MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average
Full Stroke0.7ms*
8.5ms*
15.7ms*

Rotational Speed 7,200 rpm

Operating Temperature 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s¹
Sequential Write up to 226MB/s¹

Enterprise Class Features High Reliability

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

| 500GB SATA | 7.2K SED |
|------------|----------|
| 2.5" HDD | |

Capacity500GBProtocolSATAForm Factor2.5"

Height 0.275 in; 0.7 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 2.75 in; 6.99 cm

Up to 600MB/s*

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Single Track 1ms*



^{*}Actual performance may vary.

^{*}Actual performance may vary.

25ms (Typical)*

Technical Specifications - Hard Drives

Seek Time (typical reads, Average 4.2ms*

includes controller overhead, including

settling)

7.200 rpm

Full Stroke

Rotational Speed

Operating Temperature 32° to 131° F (0° to 60° C)

Self-Encrypting Drive Yes

Support

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 Capacity 512GB TLC PCIe SSD (Z2G9)

512GB **Protocol** PCIe

Form Factor M.2 in native Slot on motherboard

NVMe Controller **NAND Type** 3D TLC

Endurance 150TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6400MB/s*

> Sequential Write 3400MB/s* **Random Read 600K IOPS* Random Write 600K IOPS***

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 Capacity 1TB TLC PCIe SSD (Z2G9)

1TB Protocol PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

300TBW (TB Written) **Endurance**

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s*

Sequential Write 5000MB/s* **Random Read** 800K IOPS* **Random Write** 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

> Capacity 2TB



^{*}Actual performance may vary.

^{*}Actual performance may vary.

PCle Protocol

Form Factor M.2 in native Slot on motherboard

1.5M Hours

Controller NVMe **NAND Type** 3D TLC

Endurance 600TBW (TB Written)

HP Z Turbo Drv PCIE-4X4 Reliability 2TB TLC PCIe SSD (Z2G9)

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s*

> **Sequential Write** 5000MB/s* **Random Read** 800K IOPS* **Random Write** 800K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 Capacity

4TB

TLC PCIe SSD

4TB PCle Protocol

Form Factor M.2 in native Slot on motherboard

Controller NVMe **NAND Type** 3D TLC

1200TBW (TB Written) **Endurance**

Reliability (MTBF) 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s*

Sequential Write 5000MB/s* **Random Read 700K IOPS* Random Write 700K IOPS***

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE

Gen4x4 4TB

TLC PCIe SED OPAL2

4TB Capacity Protocol PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe **NAND Type** 3D TLC

Endurance 1200TBW (TB Written) Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s*

> **Sequential Write** 5000MB/s* **Random Read 700K IOPS* Random Write 700K IOPS***



^{*}Actual performance may vary.

^{*}Actual performance may vary.

Self-Encrypting Drive

OPAL2

Support

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv 512GB TLC PCIe SED OPAL2 (Z2G9) Capacity 512GB Protocol PCle

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 150TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6400MB/s*

Sequential Write 3400MB/s*
Random Read 600K IOPS*
Random Write 600K IOPS*

Self-Encrypting Drive OPAL2

Support

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

| HP Z Turbo Drv 1TB |
|---------------------------|
| TLC PCIe SED |
| OPAL2 (Z2G9) |

Capacity 1TB Protocol PCle

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s*

Sequential Write 5000MB/s*
Random Read 800K IOPS*
Random Write 800K IOPS*

Self-Encrypting Drive 0

Support

OPAL2

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv 2TB TLC PCIe SED OPAL2 (Z2G9) Capacity 2TB Protocol PCIe

Form Factor M.2 in native Slot on motherboard

^{*}Actual performance may vary.

Controller NVMe NAND Type 3D TLC

Endurance 600TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s*

Sequential Write 5000MB/s*
Random Read 800K IOPS*
Random Write 800K IOPS*

Self-Encrypting Drive OPAL2

Support

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

256GB 2280 PCIe-4x4 Value M.2 SSD **Capacity** 256GB **Protocol** PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 200TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

Performance Sequential Read 3100MB/s*

Sequential Write 1400MB/s*
Random Read 200K IOPS*
Random Write 400K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

512GB 2280 PCIe-4x4 Value M.2 SSD **Capacity** 512GB **Protocol** PCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 300TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3400MB/s*

Sequential Write 2500MB/s*
Random Read 380K IOPS*
Random Write 430K IOPS*



^{*}Actual performance may vary.

Technical Specifications - Hard Drives

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB 2280 PCIe-4x4 ValueCapacity1TBM.2 SSDProtocolPCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 400TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 158° F (0° to 70° C)

Performance Sequential Read 3400MB/s*

Sequential Write 2500MB/s*
Random Read 500K IOPS*
Random Write 440K IOPS*

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.



^{*}Actual performance may vary.

AMD Radeon™ Pro W6600 8GB Graphics **Form Factor** Single slot, full-height, 9.5" length

Graphics Controller Navi23 architecture
Power: 122 Watts

Cooling Solution: Active Fan Heatsink

Cooling Solution. Active Fair neatSin

Bus TypePCI Express 4.0 x8Memory8GB GDDR6 Memory

Memory Bandwidth: 224 GB/s Memory Interface: 128 bit

Connectors 4x DisplayPort™ 1.4 with DSC

- HDR Ready

- Supports Multi-Stream Transport (MST)

Max simultaneous

displays

@ 60Hz with HDR Enabled 4x @ 3840x2160px (4K) 4x @ 5120x2880px (5K)

1x @ 7680x4320px (8K)

Shading Architecture

Supported Graphics APIs

DirectX 12 Shader Model 6.5

DirectX®12 Ultimate OpenGL® 4.6

OpenCL™ 2.1 Vulkan™ 1.2

Available Graphics

Drivers

Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

AMD Radeon™ Pro W6800 Form Factor

32GB Graphics

Double slot, full-height, 10.5" length

Graphics Controller Navi21 architecture

Power: 261 Watts

Cooling Solution: Active Fan Heatsink

Bus Type PCI Express 4.0 x16 **Memory** 8GB GDDR6 Memory

Memory Bandwidth: 512 GB/s Memory Interface: 256 bit

Connectors 6x Mini-DisplayPort™ 1.4 with DSC

- HDR Ready

- Supports Multi-Stream Transport (MST)

Max simultaneous

displays

@ 60Hz with HDR Enabled 6x @ 3840x2160px (4K)

6x @ 5120x2880px (5K) 2x @ 7680x4320px (8K)

Shading Architecture

DirectX 12 Shader Model 6.5

Supported Graphics APIs DirectX®12 Ultimate

OpenGL® 4.6 OpenCL™ 2.1 Vulkan™ 1.2



NVIDIA® T400 2GB Graphics*

Form Factor Single Slot, Low Profile (2.7" H x 6.1" L)

Graphics Controller Turing architecture Max Power: 30 Watts

Cooling Solution: Active fan heatsink

Bus Type PCI Express 3.0 x16 2GB GDDR6 Memory Memory

> Memory Bandwidth: 80 GB/s Memory Interface: 64 bit

Connectors 3x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous - 3x 3840 x 2160 @ 120Hz displays - 3x 5120 x 2880 @ 60Hz

supports Multi-Stream Transport (MST)

Shading Architecture DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.6

> DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics Drivers Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

*May go End of Life in late 2022

NVIDIA® T400 4GB Graphics

Form Factor Single Slot, Low Profile (2.7" H x 6.1" L)

Turing architecture **Graphics Controller** Max Power: 30 Watts

Cooling Solution: Active fan heatsink

PCI Express 3.0 x16 **Bus Type** Memory 4GB GDDR6 Memory

> Memory Bandwidth: 80 GB/s Memory Interface: 64 bit

3x mDP (Mini DisplayPort™) 1.4 Connectors **Connectors**

Max simultaneous

displays - 3x 3840 x 2160 @ 120Hz - 3x 5120 x 2880 @ 60Hz

supports Multi-Stream Transport (MST)

Shading Architecture DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics Drivers Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® T600 4GB Graphics*

Form Factor Single Slot, Low Profile (2.7" H x 6.1" L)

Graphics Controller Turing architecture

Max Power: 40 Watts

Cooling Solution: Active fan heatsink

Bus Type PCI Express 3.0 x16 Memory 4GB GDDR6 Memory

> Memory Bandwidth: 160 GB/s Memory Interface: 128 bit

Connectors 4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous

displays

- 4x 3840 x 2160 @ 120Hz - 4x 5120 x 2880 @ 60Hz - 2x 7680 x 4320 @ 60Hz

supports Multi-Stream Transport (MST)

Shading Architecture

DirectX 12 Shader Model 5.1 OpenGL 4.6

Supported Graphics APIs

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics Drivers

Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

*May go End of Life in late 2022

NVIDIA® T1000 4GB Graphics

Form Factor Single Slot, Low Profile (2.7" H x

6.1" L)

Graphics Controller Turing architecture

Max Power: 50 Watts

Cooling Solution: Active fan heatsink

PCI Express 3.0 x16 **Bus Type** Memory 4GB GDDR6 Memory

> Memory Bandwidth: 160 GB/s Memory Interface: 128 bit

Connectors 4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous

- 4x 3840 x 2160 @ 120Hz - 4x 5120 x 2880 @ 60Hz displays

- 2x 7680 x 4320 @ 60Hz

- supports Multi-Stream Transport (MST)

Shading Architecture

DirectX 12 Shader Model 5.1



Technical Specifications - Graphics

Supported Graphics APIs OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2

Available Graphics

Drivers

Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® T1000 8GB Graphics

Single Slot, Low Profile (2.7" H x **Form Factor**

6.1" L)

Graphics Controller Turing architecture

Max Power: 50 Watts

Cooling Solution: Active fan heatsink

Bus Type PCI Express 3.0 x16 8GB GDDR6 Memory Memory

> Memory Bandwidth: 160 GB/s Memory Interface: 128 bit

Connectors 4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous

displays

- 4x 3840 x 2160 @ 120Hz - 4x 5120 x 2880 @ 60Hz - 2x 7680 x 4320 @ 60Hz

- supports Multi-Stream Transport (MST)

Shading Architecture

DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics

Drivers

Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX™ A2000 12GB Graphics

Form Factor Low-Profile Double Slot (2.7" H x

6.1" L)

Graphics Controller Ampere architecture

Power: 70 Watts

Cooling: Active Fan Heatsink

Bus Type PCI Express 4.0 x16 **Memory** 12GB GDDR6 memory

Memory Bandwidth: 288 GB/s Memory Interface: 192 bit

Support Error-correcting code (ECC)

4x mDP (Mini DisplayPort™) 1.4 Connectors **Connectors**

Shader Model 6.5

Max simultaneous

4x 4096 x 2160 @ 120 Hz, displays 4x 5120 x 2880 @ 60 Hz

2x 7680 x 4320 @ 60 Hz

Shading Architecture Supported Graphics APIs

OpenGL 4.6 DirectX 12

Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics

Drivers

Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX™ A4000 **16GB Graphics**

Form Factor Full Height Single Slot (9.5"

Length)

Graphics Controller Ampere architecture

Power: 140 Watts

Cooling: Active Fan Heatsink

PCI Express 4.0 x16 **Bus Type Memory** 16GB GDDR6 memory

Memory Bandwidth: 448 GB/s Memory Interface: 256 bit

Support Error-correcting code (ECC)

Connectors Max simultaneous

displays

4x 4096 x 2160 @ 120 Hz, 4x 5120 x 2880 @ 60 Hz, 2x 7680 x 4320 @ 60 Hz

4x DP 1.4 Connectors

Shading Architecture Supported Graphics APIs

Shader Model 6.5 OpenGL 4.6 DirectX 12

Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics

Drivers

Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX™ A4500 **20GB Graphics**

Full Height Double Slot (10.5" **Form Factor**

Length)

Graphics Controller Ampere architecture

Power: 200 Watts

Cooling: Active Fan Heatsink

Technical Specifications - Graphics

Bus Type PCI Express 4.0 x16 **Memory** 20GB GDDR6 memory

Memory Bandwidth: 640 GB/s Memory Interface: 320 bit

Support Error-correcting code (ECC)

 Connectors
 4x DP 1.4 Connectors

 Max simultaneous
 4x 4096 x 2160 @ 120 Hz,

 displays
 4x 5120 x 2880 @ 60 Hz,

 2x 7680 x 4330 @ 60 Hz,

2x 7680 x 4320 @ 60 Hz **Architecture** Shader Model 6.5

Shading Architecture Shader Model 6
Supported Graphics APIs OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

Available Graphics Windows 10 64-bit **Drivers** Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX™ A5000 24GB Graphics Form Factor Full Height Double Slot (10.5"

Length)

Graphics Controller Ampere architecture

Power: 230 Watts

Cooling: Active Fan Heatsink

Bus Type PCI Express 4.0 x16 **Memory** 24GB GDDR6 memory

Memory Bandwidth: 768 GB/s Memory Interface: 384 bit

Support Error-correcting code (ECC)

 Connectors
 4x DP 1.4 Connectors

 Max simultaneous
 4x 4096 x 2160 @ 120 Hz,

 displays
 4x 5120 x 2880 @ 60 Hz,

 3x 7690 x 4330 @ 60 Hz,

2x 7680 x 4320 @ 60 Hz

Shading Architecture Shader Model 6.5 Supported Graphics APIs OpenGL 4.6

> DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2

Available Graphics Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html



| AM | DI | Rac | leo | n™ |
|----|----|-----|-----|----|
| RX | 67 | 00 | XT | • |

Form Factor Dual slot, Full Length (254mm L x

38mm W x 108.65mm H)

Graphics Controller AMD Radeon™ RX 6700 XT Graphics

GPU: 2560 Navi2 Stream Processors

Memory: 12GB GDDR6

Power: 230 Watts, Standard graphics 8pin + 6pin auxiliary power

Cooling: Active, Dual Axial fan

Bus Type PCI Express 4.0 x16

Connectors 3DP 1.4 + HDMI 2.1 Outputs **Maximum Resolution** DisplayPort™ 1.4 with DSC:

- up to 4x 5210 x 3200 x 24 bpp @ 60Hz, uncompressed

- up to 7680 x 4320, compressed Display Outputs 3 DP + 1 HMDI

Shading Architecture Microsoft DirectX 12 Shader Model 6.1

Supported Graphics APIs OpenGL 4.6

DirectX 12 Feature Level 12_1

Vulkan 1.1 OpenCL 2.2 Windows 11

Available Graphics Windows 1

Drivers Linux® 64-bit (selected distributions)

Typically, latest drivers will be available from amd.com

Notes: This is a Prosumer or Consumer graphics card, and not a Professional graphics card. As such, it does not have formal professional application validation, but is intended per AMD to function properly for game development, real-time engine, and many prosumer application workloads. Customers using Prosumer or Consumer graphic cards are likely to experience higher acoustics in comparison with Professional graphic cards. The higher acoustics observed with non-professional graphics is expected, as HP Workstations' designs do not have control in this area.

HP 9.5mm Slim DVD Writer

Description 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-R

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Access Times Full Stroke DVD < 200 ms (seek)
Full Stroke CD < 200 ms (seek)

Maximum Data Transfer CD ROM Read

Rates

D DOM Dood

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X



DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power SATA DC power receptacle Source

> **DC Power Requirements** $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$

DC Current 5 VDC -< 800 mA typical, <1600 mA maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 80% **Maximum Wet Bulb** 84° F (29° C)

Temperature

Operating Systems Supported

Supported

Windows 11, Windows 10, Windows 7 Professional 64-bit,

Windows Vista Business 64*, Windows 2000.

I inux®.

Kit Contents HP SATA DVD Writer drive, installation guide.

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0.

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

HP 9.5mm Slim DVD-ROM Description Drive

9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA / ATAPI **Dimensions** (WxHxD) 128 x 9.5 x 127mm

Disc Capacity DVD-ROM Single laver: Up to 4.7 GB

Double layer: Up to 8.5 GB

Access Times DVD-ROM Single Layer < 110 ms (typical)

> **CD-ROM Mode 1** < 110 ms (typical) **Full Stroke DVD** < 230 ms (typical) **Full Stroke CD** < 220 ms (typical)

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC - <800mA typical, < 1600 mA maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-

Relative Humidity 10% to 80% condensing) **Maximum Wet Bulb** 84° F (29° C)

Temperature

Operating Systems Windows 11, Windows 10, Windows 7 Professional 64-bit,

Windows Vista Business 64*, Windows 2000.

Technical Specifications - Graphics

Linux®.

Kit Contents 9.5mm Slim DVD-ROM Drive, slim SATA data/power cable, installation

guide

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.



Technical Specifications - Networking and Communications

Integrated Intel® I219LM Connector

PCIe GbE Controller (Intel® vPro® with Intel® AMT 16.01) Connector RJ-45

Cabling Twisted pair up to 100m

Controller Intel® I219LM GbE platform LAN connect networking controller

Memory 3 KB Tx and 3KB Rx FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u,

802.3z

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (S0 state) and SMBus for

host and management traffic (Sx low power state)

Power Requirement Requires 3.3V (integrated regulators for core Vdc)

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities vPro®, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI,

Advanced cable diagnostic, loopback modes,

AMT 16.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery

(MLD)

¹Requires activation and a system with a corporate network connection, an Intel® AMT enabled chipset, and network hardware and software. For notebooks, Intel AMT may be unavailable or limited over a host OS-based VPN, when connecting wirelessly, on battery power, sleeping, hibernating, or powered off. Results dependent upon hardware, setup, and configuration. For more information, visit: https://www.intel.com/content/www/us/en/architecture-and-technology/intel-active-management-technology.html

HP 1-Port 1GbE Flex IO NIC

Connector RJ-45

Cabling 1GbE over Category 5e (or better) up to 100m

Controller Realtek RTL8153

Data Rates Supported 10/100/1000 Mbps

Compliance 802.3 (LAN)

802.3u (100BASE-TX) 802.3ab (1000BASE-T) 802.3x (Ethernet Flow Control)

802.1Q (Virtual LAN)

802.3az (Energy Efficient Ethernet)

Bus Architecture USB

Power Requirement Requires 3.3V (integrated regulators for core Vdc)

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps



Technical Specifications - Networking and Communications

100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature

32° to 131° F (0° to 55° C)

Dimensions (HxW)

1.5 in x 1.5 in. x 0.75 in (3.81 cm x 3.81 cm x 1.9 cm)

Operating System Driver Windows 11 64-bit

Support

Windows 10 64-bit

Linux®

Intel® X550-T2 2-Port **10GbE NIC**

Connector Dual-port RJ-45

Cabling 10GbE: Cat6a (or better) up to 100m

5GbE and below: Cat5e (or better) up to 100m

Controller Intel® Ethernet Controller X550 **Network Transfer Rates**

10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE

Supported

Data Path Width PCIe Gen3x4

Power Requirement 11.2W (typical) 13.0 (Maximum)

Operating Temperature

Dimensions (HxW)

32° to 131° F (0° to 55° C) 5.1 x 2.7 in (without brackets)

Operating System Driver Windows 11 64-Bit

Support

Windows 10 64-bit

Linux®

Kit Contents Intel® X550-T2 2-Port 10GbE NIC with standard height bracket

attached

 Low-profile bracket Product Literature

Intel® I350-T4 4-Port 1GbE NIC

Connector 4 RJ-45

Cabling Cat5e (or better) up to 100m Intel® Ethernet I350 Controller Controller

Network Transfer Rates

Supported

1GbE, 100MbE, 10MbE

Data Path Width PCIe Gen2.1x4 **Power Requirement** 5W (typical)

Operating Temperature 32° to 131° F (0° to 55° C)

Dimensions (HxW) 2.75 x 5.5 inches (without brackets)

Operating System Driver Windows 11

Support

Windows 10

Linux®

Kit Contents

Intel® 1350-T4 4-Port 1GbE NIC with standard height bracket attached

Low-profile bracket

Product Literature

HP Flex 1GbE Fiber LC Single Port

Connector

Cabling 1GbE over Category OM1 (or better) up to 100m

Controller Microchip LAN7801

Technical Specifications - Networking and Communications

Data Rates Supported

100/1000 Mbps

USB

Compliance

IEEE 802.1p priority encoding/tagging (QoS, CoS)

IEEE 802.1q VLAN tagging IEEE 802.3x flow control

Bus Architecture

Power Requirement

Requires 3.3V (integrated regulators for core Vdc)

Boot ROM Support Yes

Network Transfer Mode

Full-duplex; Half-duplex

Network Transfer Rate

100BASE-X (half-duplex) 100 Mbps 1000BASE-X (half-duplex) 1000 Mbps 1000BASE-X (full-duplex) 2000 Mbps

Operating Temperature

32° to 158° F (0°C to 70°C)

calvin

1.5 in x 1.7 in. x 0.75 in (3.84 cm x 4.3 cm x 1.9 cm)

Operating System Driver Windows 11 64-Bit

Support

Windows 11 64-Bit Windows 10 64-bit

Linux®

Intel® I225-T1 1-Port 2.5GbE NIC

Connector RJ-45

CablingCat5e (or better) up to 85mControllerIntel® Ethernet I225 ControllerNetwork Transfer Rates2.5GbE, 1GbE, 100MbE, 10MbE

Supported

PCIe Gen3.1x1

Power Requirement PCle Gen3.1x1 1.9W (typical)

Operating Temperature 32° to 158° F (0°C to 70°C)

Dimensions (HxW) 2.7 in x 2.57 in. (68.7mm x 65.3mm)

Operating System Driver Windows 11 64-Bit

Windows 10 64-bit

Linux®

* Intel® I225-T1 1-Port 2.5GbE NIC with standard height bracket attached

Low-profile bracket
• Product Literature

Intel® Wi-Fi 6E* AX211 802.11ax, BT 5.2, M.2 With Internal Antenna

WLAN Standards 802.11abgn+acR2+axR2(Pre-Standard) MIMO 2x2

High performance, low power dual band Pre-Standard-802.11ax R2 2x2,

both with 160MHz channel support - Wi-Fi 6E

Antenna 2x2 Dual-Band (internal)

Bluetooth Standards 5.2

Operating Temperature 32° to 176° F (0° to 80° C)

InterfaceM.2 CNVio2DimensionsM.2 2230Kit ContentsNot Available

NOTE: The AX211 with internal antenna only support WIFI 6

*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Technical Specifications - Networking and Communications

Intel® Wi-Fi 6E* AX211 802.11ax, BT 5.2, M.2 With External Antenna WLAN Standards 802.11abqn+acR2+axR2(Pre-Standard) MIMO 2x2

High performance, low power dual band Pre-Standard-802.11ax R2 2x2,

both with 160MHz channel support – Wi-Fi 6E

Antenna 2x2 Dual-Band (External)

Bluetooth Standards 5.2

Operating Temperature 32° to 176° F (0° to 80° C)

InterfaceM.2 CNVio2DimensionsM.2 2230

Kit Contents ANTENNA, External, Dipole, WLAN, WIFI 6E

NOTE: The AX211 with external antenna support WIFI 6E

*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

| Date of change: | Version History: | | Description of change: |
|-----------------|------------------|---------|--|
| March 8, 2022 | From v1 to v2 | Changed | Format |
| March 16, 2022 | From v2 to v3 | Changed | Social and Environmental Responsibility section |
| May 6, 2022 | From v3 to v4 | Changed | Processors, Graphics, Networking and Communications sections |
| June 1, 2022 | From v4 to v5 | Changed | Operating Systems and SATA Hard Drives sections |
| June 15, 2022 | From v5 to v6 | Changed | Networking and Communications section |



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